

## High Temperature Silicon Carbide Power Schottky Diode

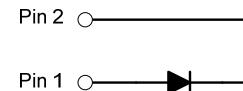
<b>V<sub>RRM</sub></b>	=	600 V
<b>I<sub>F</sub> (T<sub>c</sub>=25°C)</b>	=	4 A
<b>Q<sub>C</sub></b>	=	9 nC

### Features

- 600 V Schottky rectifier
- 210 °C maximum operating temperature
- Zero reverse recovery charge
- Superior surge current capability
- Positive temperature coefficient of V<sub>F</sub>
- Temperature independent switching behavior
- Lowest figure of merit Q<sub>C</sub>/I<sub>F</sub>
- Available screened to Mil-PRF-19500

### Package

- RoHS Compliant



TO - 46

### Advantages

- High temperature operation
- Improved circuit efficiency (Lower overall cost)
- Low switching losses
- Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Industry's lowest reverse recovery charge
- Industry's lowest device capacitance
- Ideal for output switching of power supplies
- Best in class reverse leakage current at operating temperature

### Applications

- Down Hole Oil Drilling
- Geothermal Instrumentation
- Solenoid Actuators
- General Purpose High-Temperature Switching
- Amplifiers
- Solar Inverters
- Switched-Mode Power Supply (SMPS)
- Power Factor Correction (PFC)

### Maximum Ratings at T<sub>j</sub> = 210 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit
Repetitive peak reverse voltage	V <sub>RRM</sub>		600	V
Continuous forward current	I <sub>F</sub>	T <sub>c</sub> = 25 °C	4	A
Continuous forward current	I <sub>F</sub>	T <sub>c</sub> ≤ 180 °C	2	A
RMS forward current	I <sub>F(RMS)</sub>	T <sub>c</sub> ≤ 180 °C	4	A
Surge non-repetitive forward current, Half Sine Wave	I <sub>F,SM</sub>	T <sub>c</sub> = 25 °C, t <sub>p</sub> = 10 ms	10	A
Non-repetitive peak forward current	I <sub>F,max</sub>	T <sub>c</sub> = 25 °C, t <sub>p</sub> = 10 μs	65	A
i <sup>2</sup> t value	∫i <sup>2</sup> dt	T <sub>c</sub> = 25 °C, t <sub>p</sub> = 10 ms	0.5	A <sup>2</sup> S
Power dissipation	P <sub>tot</sub>	T <sub>c</sub> = 25 °C	64	W
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>		-55 to 210	°C

### Electrical Characteristics at T<sub>j</sub> = 210 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Diode forward voltage	V <sub>F</sub>	I <sub>F</sub> = 1 A, T <sub>j</sub> = 25 °C I <sub>F</sub> = 1 A, T <sub>j</sub> = 210 °C	1.6 2.6			V
Reverse current	I <sub>R</sub>	V <sub>R</sub> = 600 V, T <sub>j</sub> = 25 °C V <sub>R</sub> = 600 V, T <sub>j</sub> = 210 °C	1 5	5	50	μA
Total capacitive charge	Q <sub>C</sub>	I <sub>F</sub> ≤ I <sub>F,MAX</sub>	9			nC
Switching time	t <sub>s</sub>	dI <sub>F</sub> /dt = 200 A/μs T <sub>j</sub> = 210 °C	< 17			ns
Total capacitance	C	V <sub>R</sub> = 1 V, f = 1 MHz, T <sub>j</sub> = 25 °C V <sub>R</sub> = 600 V, f = 1 MHz, T <sub>j</sub> = 25 °C	76 15			pF

### Thermal Characteristics

Thermal resistance, junction - case	R <sub>thJC</sub>	5.55	°C/W
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### Mechanical Properties

Mounting torque	M	0.6	Nm
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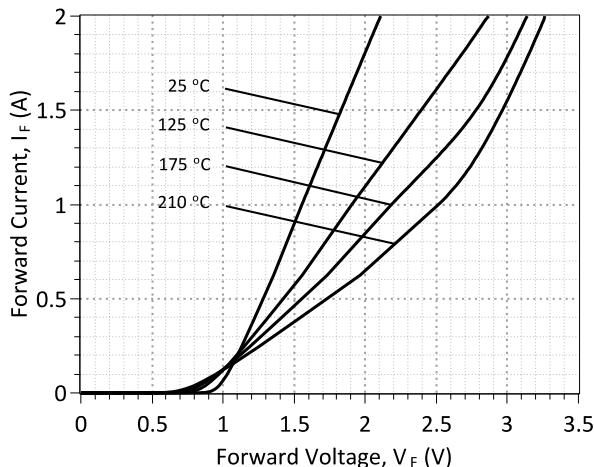


Figure 1: Typical Forward Characteristics

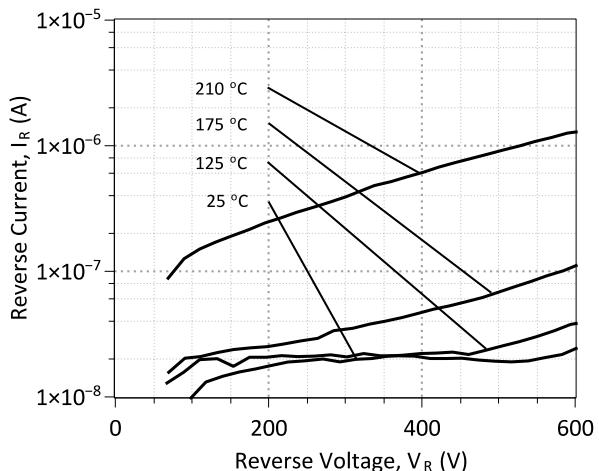


Figure 2: Typical Reverse Characteristics

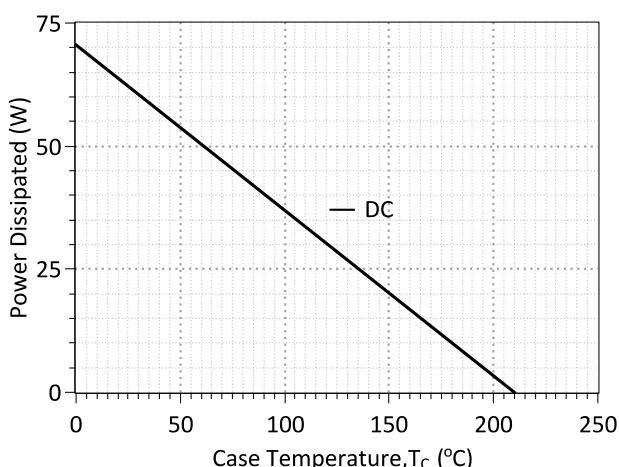


Figure 3: Power Derating Curve

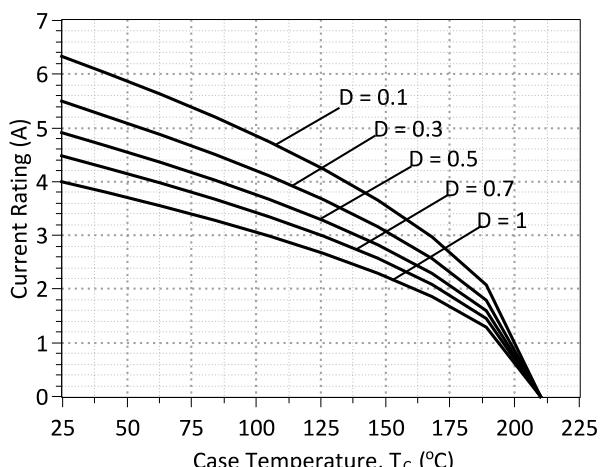


Figure 4: Current Derating Curves ( $D = t_p/T$ ,  $t_p = 400 \mu s$ )  
 (Considering worst case  $Z_{th}$  conditions )

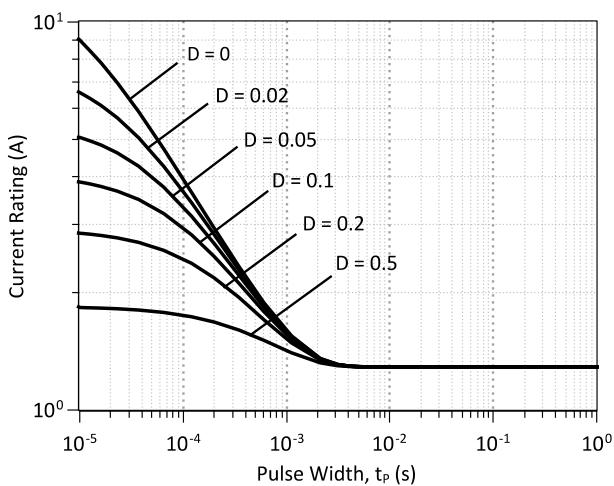


Figure 5: Current vs Pulse Duration Curves at  $T_c = 190$  °C

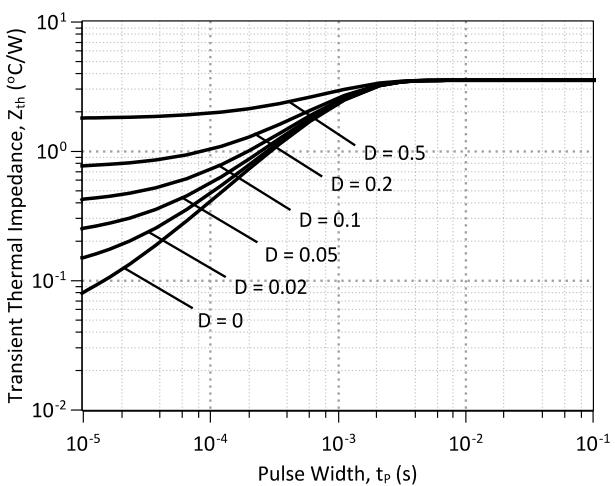
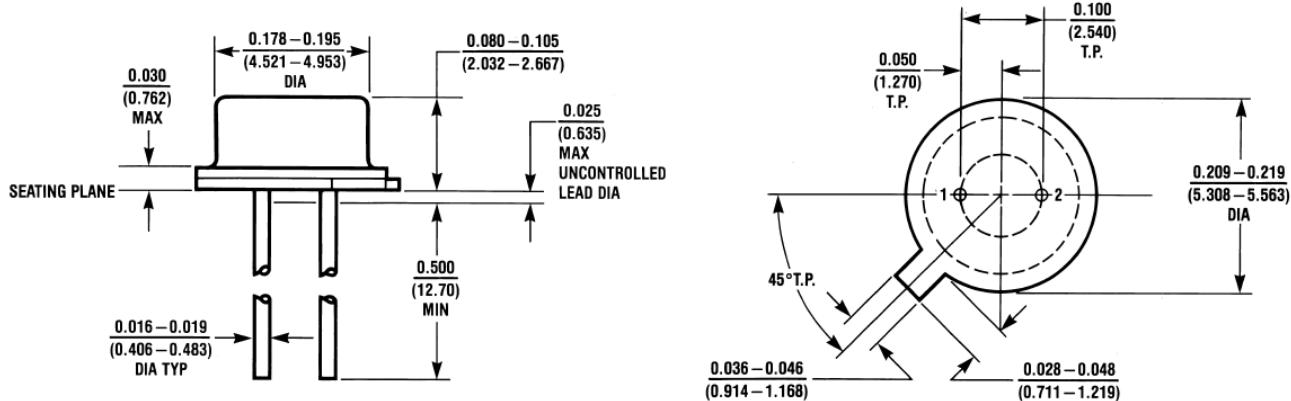


Figure 6: Transient Thermal Impedance

**Package Dimensions:**
**TO-46**
**PACKAGE OUTLINE**

**NOTE**

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS

**Revision History**

Date	Revision	Comments	Supersedes
2014/08/29	0	Initial release	

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## SPICE Model Parameters

This is a secure document. Copy this code from the SPICE model PDF file on our website into a SPICE software program for simulation of the GB02SHT06-46.

```

* MODEL OF GeneSiC Semiconductor Inc.
*
* $Revision: 1.0      $
* $Date: 29-AUG-2014   $
*
* GeneSiC Semiconductor Inc.
* 43670 Trade Center Place Ste. 155
* Dulles, VA 20166
*
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* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
*
* Start of GB02SHT06-46 SPICE Model
*
.SUBCKT GB02SHT06ANODE KATHODE
D1 ANODE KATHODE GB02SHT06_25C; Call the Schottky Diode Model
D2 ANODE KATHODE GB02SHT06_PIN; Call the PiN Diode Model
.MODEL GB02SHT06_25C D
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+ TRS1    0.0057      TRS2    2.40E-05
+ N       1            IKF     322
+ EG      1.2          XTI     3
+ CJO     9.12E-11     VJ      0.371817384
+ M       1.527759838   FC      0.5
+ TT      1.00E-10     BV      600
+ IBV    1.00E-03     VPK     600
+ IAVE    2            TYPE    Sic_Schottky
+ MFG    GeneSiC_Semiconductor
.MODEL GB02SHT06_PIN D
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+ N       5            IKF     800
+ EG      3.23         XTI    -14
+ FC      0.5          TT      0
+ BV      600          IBV    1.00E-03
+ VPK    600          IAVE    2
+ TYPE   Sic_Pin
.ENDS
*
* End of GB02SHT06 SPICE Model

```

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